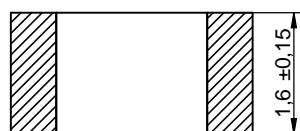


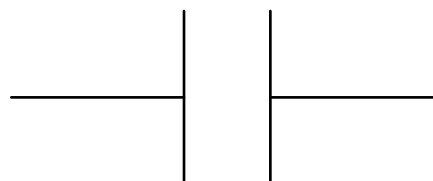
Dimensions: [mm]



Recommended Land Pattern: [mm]



Schematic:



Electrical Properties:

Properties		Test conditions	Value	Unit	Tol.
Capacitance	C	$1 \pm 0.2 V_{RMS}$, 1 kHz $\pm 10\%$ @25 °C	3.3	nF	$\pm 5\%$
Rated Voltage	V_R		100	V (DC)	max.
Q-Factor	Q	$1 \pm 0.2 V_{RMS}$, 1 kHz $\pm 10\%$ @25 °C	1000		min.
Insulation Resistance	R_{ISO}	Apply V_R for 120 s max.	10	GΩ	min.

Precondition for Class II MLCC measurement: Apply a preheat treatment @150 ± 10 °C for 1 hour. The measurement should be applied after 24 ± 2 hrs the part was stored under ambient conditions. There is not any precondition necessary for Class I MLCC.

General Information:

General Purpose MLCC	
Ceramic Type	NPO Class I
Temperature Coefficient	± 30 ppm/ °C max.
Operating Temperature	-55 up to +125 °C
Storage Conditions (in original packaging)	5 °C up to + 35 °C; 10 % up to 75 % RH
Moisture Sensitivity Level (MSL)	1
Dielectric Strength	5 sec. @250 % V_R ; Charge & Discharge Current <50 mA
Test conditions of Electrical Properties: +20 °C, 35 % RH if not specified differently	
FIT according to separate documentation	



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eiSos@we-online.com

CHECKED	REVISION	DATE (YYYY-MM-DD)	GENERAL TOLERANCE	PROJECTION METHOD
PSL	002.000	2021-01-03	DIN ISO 2768-1m	
DESCRIPTION			TECHNICAL REFERENCE	
WCAP-CSGP Ceramic Capacitors			NP01206332J100DFCT10000	
1206			ORDER CODE	
			885012008076	
SIZE/TYPE	BUSINESS UNIT	STATUS	PAGE	
1206	eiCap	Valid	1/9	


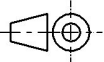
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Mechanical Properties

Properties	Definition	
Adhesive Strength of Termination	0201	10 ±1 sec; 2 N
	0402 & 0603	10 ±1 sec; 5 N
	> 0603	10 ±1 sec; 10 N
Vibration Resistance		all 3 directions, 2 hours each @ 10 - 55 Hz/ min., amplitude 0.75 mm or 10 g
Resistance to Solder Heat	Specific	Refer to Soldering Profile

Certification:

RoHS Approval	Compliant [2011/65/EU&2015/863]
REACH Approval	Conform or declared [(EC)1907/2006]
Halogen Free	Conform [JEDEC JS709B]
Halogen Free	Conform [IEC 61249-2-21]

 WE WÜRTH ELEKTRONIK	CHECKED PSL	REVISION 002.000	DATE (YYYY-MM-DD) 2021-01-03	GENERAL TOLERANCE DIN ISO 2768-1m	PROJECTION METHOD 
	DESCRIPTION WCAP-CSGP Ceramic Capacitors 1206				TECHNICAL REFERENCE NP01206332J100DFCT10000
	ORDER CODE 885012008076				STATUS Valid
SIZE/TYPE 1206		BUSINESS UNIT eiCap			
Würth Elektronik eiSos GmbH & Co. KG EMC & Inductive Solutions Max-Eyth-Str. 1 74638 Waldenburg Germany Tel. +49 (0) 79 42 945 - 0 www.we-online.com eiSos@we-online.com					

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Packaging Specification - Tape: [mm]



Packaging is referred to the international standard IEC 60286-3:2019

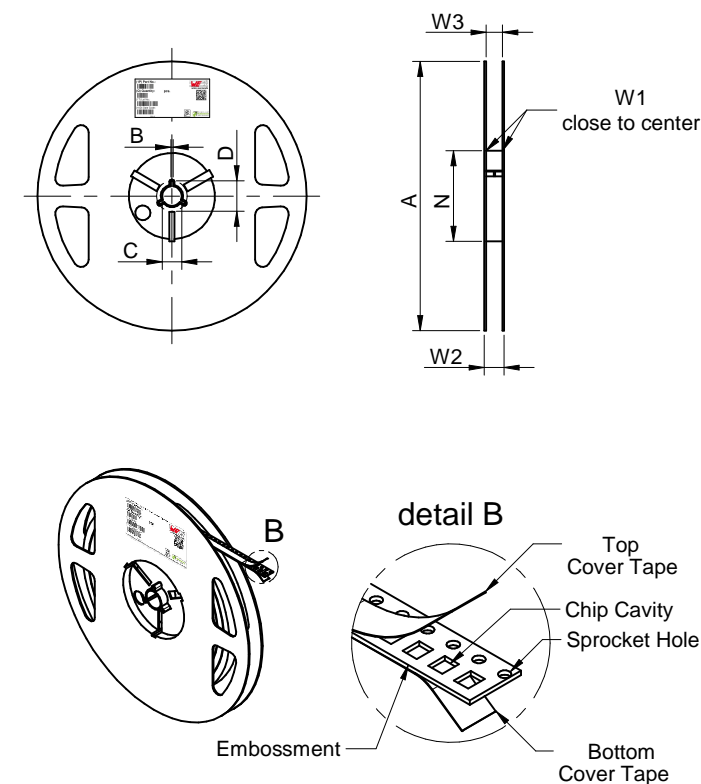
Tape Type	A0 (mm)	B0 (mm)	W (mm)	T (mm)	T1 (mm)	P0 (mm)	P1 (mm)	P2 (mm)	D0 (mm)	E1 (mm)	E2 (mm)	F (mm)	Material	Qty. (pcs.)
	typ.	typ.	+0,3/-0,1	ref.	ref.	±0,1	±0,1	+0,05	+0,1 / -0,0	±0,1	min.	±0,05		
1a	1,90	3,50	8,00	1,30	0,10	4,00	4,00	2,00	1,50	1,75	6,25	3,50	Paper	4000



Pull-of force		
Tape width	8 mm	0,1 N - 1,0 N

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Packaging Specification - Reel: [mm]



A (mm)	B (mm)	C (mm)	D (mm)	N (mm)	W1 (mm)	W2 (mm)	W3 (mm)	W3 (mm)	Material
± 2,0	min.	min.	min.	min.	+1,5	max.	min.	max.	
178	1,5	12,8	20,2	50	8,4	14,4	7,9	10,9	Polystyrene

CHECKED PSL	REVISION 002.000	DATE (YYYY-MM-DD) 2021-01-03	GENERAL TOLERANCE DIN ISO 2768-1m	PROJECTION METHOD
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ORDER CODE 885012008076				
SIZE/TYPE 1206	BUSINESS UNIT eiCap	STATUS Valid	PAGE 3/9	

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Packaging Specification - Inner Carton: [mm]



L _{IC} (mm)	W _{IC} (mm)	H _{IC} (mm)	No. of Reel (pcs.)	Qty. (pcs.)	Material
typ.	typ.	typ.			
120,00	180,00	180,00	10	40000	Paper

Packaging Specification - Outer Carton: [mm]



L _C (mm)	W _C (mm)	H _C (mm)	No. of Inner Carton (pcs.)	Qty. (pcs.)	Material
typ.	typ.	typ.			
393,00	393,00	203,00	6	240000	Paper

	CHECKED	REVISION	DATE (YYYY-MM-DD)	GENERAL TOLERANCE	PROJECTION METHOD
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			885012008076		
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1206			eiCap	Valid	4/9

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Classification Reflow Profile for SMT components:



Classification Reflow Soldering Profile:

Profile Feature		Value
Preheat Temperature Min	$T_{s \text{ min}}$	150 °C
Preheat Temperature Max	$T_{s \text{ max}}$	200 °C
Preheat Time t_s from $T_{s \text{ min}}$ to $T_{s \text{ max}}$	t_s	60 - 120 seconds
Ramp-up Rate (T_L to T_p)		3 °C/ second max.
Liquidous Temperature	T_L	217 °C
Time t_L maintained above T_L	t_L	60 - 150 seconds
Peak package body temperature	T_p	$T_p \leq T_c$, see Table below
Time within 5°C of actual peak temperature	t_p	20 - 30 seconds
Ramp-down Rate (T_p to T_L)		6 °C/ second max.
Time 25°C to peak temperature		8 minutes max.

refer to IPC/ JEDEC J-STD-020E

Package Classification Reflow Temperature (T_c):

Properties	Volume mm ³ <350	Volume mm ³ 350-2000	Volume mm ³ >2000
PB-Free Assembly Package Thickness < 1.6 mm	260 °C	260 °C	260 °C
PB-Free Assembly Package Thickness 1.6 mm - 2.5 mm	260 °C	250 °C	245 °C
PB-Free Assembly Package Thickness > 2.5 mm	250 °C	245 °C	245 °C

refer to IPC/ JEDEC J-STD-020E

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Classification Wave Soldering Profile:



Classification Wave Soldering Profile:

Profile Feature		Pb-Free Assembly	Sn-Pb Assembly
Preheat Temperature Min	$T_{s\ min}$	100 °C	100 °C
Preheat Temperature Typical	$T_{s\ typical}$	120 °C	120 °C
Preheat Temperature Max	$T_{s\ max}$	130 °C	130 °C
Preheat Time t_s from $T_{s\ min}$ to $T_{s\ max}$	t_s	70 seconds	70 seconds
Ramp-up Rate	ΔT	150 °C max.	150 °C max.
Peak Temperature	T_p	250 °C - 260 °C	235 °C - 260 °C
Time of actual peak temperature	t_p	max. 10 seconds max. 5 seconds each wave	max. 10 seconds max. 5 seconds each wave
Ramp-down Rate, Min		~ 2 K/ second	~ 2 K/ second
Ramp-down Rate, Typical		~ 3.5 K/ second	~ 3.5 K/ second
Ramp-down Rate, Max		~ 5 K/ second	~ 5 K/ second
Time 25 °C to 25 °C		4 minutes	4 minutes

refer to EN61760-1:2006

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Cautions and Warnings:

The following conditions apply to all goods within the product series of MLCCs of Würth Elektronik eiSos GmbH & Co. KG:

General:

- This electronic component is designed and manufactured for use in general electronic equipment.
- Würth Elektronik must be asked for a written approval (following the certain PPAP level procedure) before incorporating the components into any equipment in the field such as military, aerospace, aviation, nuclear control, submarine, transportation (automotive control, train control, ship control), transportation signal, disaster prevention, medical, public information network etc. where higher safety and reliability are especially required and/or if there is the possibility of direct damage or human injury.
- Electronic components that will be used in safety-critical or high-reliability applications, should be pre-evaluated by the customer.
- Direct mechanical impact to the product shall be prevented as material of the body, pins or termination could flake or in the worst case it could break.
- Avoid any water or heavy dust on capacitors surface, which may cause electrical leakage, damage, overheating or corrosion.
- Würth Elektronik products are qualified according to international standards, which are listed in each product reliability report. Würth Elektronik does not warrant any customer qualified product characteristic, beyond Würth Elektronik specifications, for its validity and sustainability over time.
- The responsibility for the applicability of the customer specific products and use in a particular customer design is always within the authority of the customer. All technical specifications for standard products also apply to customer specific products.
- The component is designed and manufactured to be used within the datasheet specified values. If the usage and operation conditions specified in the datasheet are not met, the wire insulation may be damaged or dissolved.
- Do not drop or impact the components, the component may be damaged.
- The capacitance tolerance as specified within the datasheet is only valid on the date of delivery and according specified measurement criteria.

Product specific:

Storage conditions:

- A storage of Würth Elektronik products for longer than 12 months is not recommended. Within other effects, the terminals may suffer degradation, resulting in bad solderability. Therefore, all products shall be used within the period of 12 months based on the day of shipment.
- Do not expose the components into direct sunlight.
- The storage condition in the original packaging is defined according to DIN EN 61760-2.
- The environment in which the capacitors are operated and stored has to have atmospheric characteristics and must be free of dew condensation and toxic gases (e.g. chlorine, ammonia, sulfur, hydrogen sulphide and hydrogen sulfate).
- The storage conditions stated in the original packaging apply to the storage time and not to the transportation time of the components.

Operating climatic conditions:

- Do not exceed the lower nor the upper specified temperature under no circumstances.
- Be aware that the specified capacitance tolerance is only valid at the date of delivery.
- Do not use the capacitors under high humidity, high temperature nor under high or low atmospheric pressure which may affect capacitors reliability.
- Surface temperature including self-heating must be kept below the maximum operating temperature.
- The temperature rise of the capacitor's temperature compared to ambient temperature shall be below 20°C.

Operating load conditions:

- Operating voltage across the terminals including AC and DC peaks and AC or pulse overshooting, V_p-p , as well as irregular voltage because of resonance or switching must be below the rated voltage.
- Due to self-heating the reliability of the capacitor may be reduced, if high frequency AC or pulse is applied.
- Consider carefully possible specific changes of electrical characteristics like capacitance over temperature, voltage and time as well as the specific performance over frequency for the actual use conditions.

Design of the PCB:



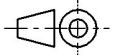
- The chip capacitor shall be located to minimize any possible mechanical stress from deflection or board wrap.
- It is recommended to position the chip capacitor in parallel to slits and perforations and as far away from slits, perforations, separation points, screw holes, frames and edges of the PCB to avoid mechanical stress.
- The PCB design (e.g. land pattern design and grounding planes) must be evaluated for each individual circuit to achieve the optimal soldering results.

Mounting:

- Adjust the bottom dead center of the mounting head not to press on the PCB surface.
- Provide support from the bottom side of the PCB by a support pin for minimizing the impact energy from the mounting head.

Adhesive:

- The adhesive should have sufficient coating and viscosity and should harden rapidly.
- The adhesive should be strong enough to hold parts on the board during the mounting and solder process and should have sufficient strength at high temperatures.
- The adhesive should have corrosion resistance, excellent insulation characteristics and no emission of toxic gasses nor any effect on the human body.
- Do not use too much adhesive to avoid pollution of the soldering pads.

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Soldering:

- The solder profile must comply with the technical product specifications. All other profiles will void the warranty.
- All other soldering methods are at the customer's own risk.
- Strong forces which may affect the coplanarity of the component's electrical connection with the PCB (i.e. pins), can damage the part, resulting in void of the warranty.
- Customer needs to ensure that the applied solder paste, the paste thickness and solder conditions are applicable to guarantee a sufficient solder result according to the relevant criteria of IPC-A-610.
- Excessive amount of solder may lead to higher tensile force and chip cracking. Insufficient amount of solder may detach the capacitor due to defective contacts.
- Do not use excessive nor insufficient flux.
- Provide enough washing when water-soluble flux is used.
- For reflow soldering, two times limitation is recommended.
- Wave soldering is recommended only for the following case sizes: 0603 and 0805, with maximal thickness of 0.85 mm.

Cleaning and Washing:

- Washing agents used during the production to clean the customer's application, might damage or change the characteristics of the wire insulation body, the marking or the plating. Washing agent could have a negative effect on the long term functionality of the product.
- Avoid Halogen in the flux or any contaminated flux as well as excessively high ultrasonic cleaning.


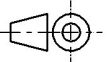

Coating, molding and potting of the PCB:

- If the product is potted in the customer's application, the potting material might shrink or expand during and after hardening. Shrinking could lead to an incomplete seal, allowing contaminants into the body and termination. Expansion could damage the body or termination. We recommend a manual inspection after potting to avoid these effects.
- When coating and molding the PCB, verify the quality influence on the capacitor.
- Verify the curing temperature and assure that there is no harmful decomposing or reaction gas emission during curing.
- Do not exceed the maximal temperature rise of 20°C.

Handling:

- After soldering, please pay attention not to bend, twist or distort the PCB in handling and storage.
- Avoid excessive pressure during the functional check of the PCB.
- Avoid bending stress while breaking the PCB.
- After mounting, avoid piling up PCBs to avoid hitting the chip capacitor of another board.

These cautions and warnings comply with the state of the scientific and technical knowledge and are believed to be accurate and reliable. However, no responsibility is assumed for inaccuracies or incompleteness.

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[CDR33BX683AKUS](#) [CGA2B2C0G1H010C](#) [CGA2B2C0G1H040C](#) [CGA2B2C0G1H050C](#) [CGA2B2C0G1H060D](#) [CGA2B2C0G1H070D](#)
[CGA2B2C0G1H120J](#) [CGA2B2C0G1H151J](#) [CGA2B2C0G1H1R5C](#) [CGA2B2C0G1H2R2C](#) [CGA2B2C0G1H390J](#) [CGA2B2C0G1H391J](#)
[CGA2B2C0G1H3R3C](#) [CGA2B2C0G1H680J](#) [CGA2B2C0G1H6R8D](#) [CGA2B2C0G1H820J](#) [CGA2B2X8R1H152K](#)